

32. (new) The device as recited in claim 29 wherein respective resistors of each respective resistor arrangement are connected between respective contact fields disposed in respective rows, a respective resistors being arranged in a fixed order with regard to their respective resistance values, the respective total resistance of each respective resistor arrangement being achieved using the respective contact fields, and wherein the respective contact fields include a plurality of bond pads for attachment of electric leads.

33. (new) The device as recited in claim 28 wherein respective resistors of the respective resistor arrangements include at least one of metal, non-metal, semiconductor material, liquid, gel, ceramic, oxide, metal-matrix compound, liquid crystals and polymers.

34. (new) The device as recited in claim 28 wherein the at least two optoelectronic components are disposed on a first body and at least a portion of the respective resistor arrangements are disposed on at least one second body.

35. (new) The device as recited in claim 34 wherein the first body includes semiconductor materials and the at least one second body includes an insulator.

36. (new) The device as recited in claim 28 wherein each of the at least two optoelectronic components includes at least one of a solid-state laser, an optical amplifier, a filter, a wavelength multiplexer and a waveguide.--.

IN THE ABSTRACT

Line 1, change "The invention relates to a cost-reductive" to --A--.

Line 2, change "comprising" to --including--.

Line 3, change "According to the invention, the" to --The--.

Line 4, change "by means of" to --using--, before "resistance" insert --respective-- and delete "(RM)".

Line 5, delete "(U₀/I)", before "heating" insert --respective-- and delete "(H)".